

LAMINATE AND METHOD FOR PRODUCING LAMINATE

ABSTRACT

Provided is a method for producing a laminate having both debris suppression and excellent positional accuracy during transfer of an article such as a semiconductor chip. The method for producing a laminate enables the production of a high-quality display device or semiconductor device. The present invention provides a method for producing a laminate, including: preparing a laminate a1x including a first substrate and a light-absorbing layer in this order; tentatively fixing an article to the light-absorbing layer; patterning the light-absorbing layer; preparing a laminate a2 including a second substrate and a second pressure-sensitive adhesive layer in this order; and irradiating the light-absorbing layer with a chemical active ray from a first substrate side of the light-absorbing layer while a gap is present between an article provided on the first substrate and the second pressure-sensitive adhesive layer provided on the second substrate to transfer the article from the light-absorbing layer to the second pressure-sensitive adhesive layer, wherein a plurality of articles are in contact with the light-absorbing layer, and a recess is formed in the light-absorbing layer.

Figure 1